

# USB Current-Limited Switches with Fault Blanking

## ABSOLUTE MAXIMUM RATINGS

IN,  $\overline{\text{ON}}$  (ON),  $\overline{\text{FAULT}}$  to GND ..... -0.3V to +6V  
 OUT to GND ..... -0.3V to ( $V_{\text{IN}} + 0.3\text{V}$ )  
 Maximum Continuous Switch Current ..... 1.2A (internally limited)  
 OUT Short Circuit to GND ..... Continuous  
 Continuous Power Dissipation ( $T_A = +70^\circ\text{C}$ )  
 10-Pin  $\mu\text{MAX}$  (derate 5.6mW/ $^\circ\text{C}$  above  $+70^\circ\text{C}$ ) ..... 444mW

Operating Temperature Range  
 MAX1693EUB/MAX1693HEUB/  
 MAX1694EUB .....  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$   
 Storage Temperature Range .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$   
 Lead Temperature (soldering, 10s) .....  $+300^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

( $V_{\text{IN}} = +5\text{V}$ ,  $T_A = 0^\circ\text{C}$  to  $+85^\circ\text{C}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ\text{C}$ .)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Voltage	$V_{\text{IN}}$			2.7		5.5	V
Quiescent Current	$I_{\text{Q}}$	$\overline{\text{ON}}$ (ON) = GND ( $V_{\text{IN}}$ ) $I_{\text{OUT}} = 0$	Timer not running		14	25	$\mu\text{A}$
			Timer running		35		
Off-Supply Current		$\overline{\text{ON}}$ (ON) = $V_{\text{IN}} = V_{\text{OUT}} = 5.5\text{V}$ ( $V_{\text{ON}} = \text{GND}$ )			0.001	1	$\mu\text{A}$
Undervoltage Lockout	UVLO	Rising edge, 100mV hysteresis		2.0		2.6	V
Off-Switch Leakage		$\overline{\text{ON}}$ (ON) = $V_{\text{IN}}$ (GND) $V_{\text{IN}} = 5.5\text{V}$ , $V_{\text{OUT}} = \text{GND}$	$T_A = +25^\circ\text{C}$		0.01	2	$\mu\text{A}$
			$T_A = 0^\circ\text{C}$ to $+85^\circ\text{C}$			15	
On-Resistance	$R_{\text{ON}}$	$T_A = +25^\circ\text{C}$ $T_A = 0^\circ\text{C}$ to $+85^\circ\text{C}$	$V_{\text{IN}} = 4.4\text{V}$ to $5.5\text{V}$		60	90	$\text{m}\Omega$
			$V_{\text{IN}} = 4.4\text{V}$ to $5.5\text{V}$			125	
			$V_{\text{IN}} = 3\text{V}$		72	150	
Current Limit	$I_{\text{LIMIT}}$	(Note 1)		700	850	1000	mA
Continuous Short-Circuit Current Limit	$I_{\text{SC}}$	OUT shorted to GND, MAX1693/(MAX1693H) only (Note 2)			500	700	mA
$\overline{\text{ON}}$ (ON) Input Logic Low Voltage	$V_{\text{IL}}$	$V_{\text{IN}} = 2.7\text{V}$ to $5.5\text{V}$				0.8	V
$\overline{\text{ON}}$ (ON) Input Logic High Voltage	$V_{\text{IH}}$	$V_{\text{IN}} = 2.7\text{V}$ to $3.6\text{V}$		2			V
		$V_{\text{IN}} = 3.7\text{V}$ to $5.5\text{V}$		2.4			
$\overline{\text{ON}}$ (ON) Input Leakage		$\overline{\text{ON}}$ (ON) = $V_{\text{IN}}$ or GND				$\pm 1$	$\mu\text{A}$
$\overline{\text{FAULT}}$ Output Logic Low Voltage	$V_{\text{OL}}$	$I_{\text{SINK}} = 1\text{mA}$ , $V_{\text{IN}} = 3\text{V}$				0.4	V
$\overline{\text{FAULT}}$ Output High Leakage Current		$V_{\text{IN}} = V_{\overline{\text{FAULT}}} = 5.5\text{V}$				1	$\mu\text{A}$
Fault-Blanking Timeout Period	$t_{\text{FB}}$	From overcurrent condition to $\overline{\text{FAULT}}$ assertion		7	10	13	ms
Start-Up Time		$V_{\text{IN}} = 5\text{V}$ , $C_{\text{OUT}} = 150\mu\text{F}$ , $R_{\text{L}} = 15\Omega$ , from $\overline{\text{ON}}$ (ON) driven low (high) to 50% full $V_{\text{OUT}}$			1		ms
Switch Turn-On Time	$t_{\text{ON}}$	$I_{\text{LOAD}} = 400\text{mA}$			80	200	$\mu\text{s}$
Switch Turn-Off Time	$t_{\text{OFF}}$	$I_{\text{LOAD}} = 400\text{mA}$		3	6	20	$\mu\text{s}$
Thermal Shutdown Threshold					165		$^\circ\text{C}$

# USB Current-Limited Switches with Fault Blanking

MAX1693/(MAX1693H)/MAX1694

## ELECTRICAL CHARACTERISTICS

( $V_{IN} = +5V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	$V_{IN}$		3		5.5	V
Quiescent Current	$I_Q$	$\overline{V_{ON}}(ON) = GND$ (GND), $I_{OUT} = 0$ , timer not running			25	$\mu A$
Off-Supply Current		$\overline{V_{ON}}(ON) = V_{IN} = V_{OUT} = 5.5V$ ( $V_{ON} = GND$ )			2	$\mu A$
Undervoltage Lockout	UVLO	Rising edge, 100mV hysteresis	2.0		2.9	V
Off-Switch Leakage		$\overline{V_{ON}}(ON) = V_{IN} = 5.5V$ , $V_{OUT} = GND$ ( $V_{ON} = GND$ )			15	$\mu A$
On-Resistance	$R_{ON}$	$V_{IN} = 4.4V$ to $5.5V$			125	$m\Omega$
		$V_{IN} = 3V$			150	
Current Limit	$I_{LIMIT}$	(Note 1)	640		1060	mA
Continuous Short-Circuit Current Limit		OUT shorted to GND, MAX1693/(MAX1693H) only (Note 2)			750	mA
$\overline{ON}$ (ON) Input Logic Low Voltage	$V_{IL}$	$V_{IN} = 3V$ to $5.5V$			0.8	V
$\overline{ON}$ (ON) Input Logic High Voltage	$V_{IH}$	$V_{IN} = 3V$ to $3.6V$	2			V
		$V_{IN} = 3.7V$ to $5.5V$	2.4			
$\overline{ON}$ (ON) Input Leakage		$\overline{V_{ON}}(ON) = V_{IN}$ or GND			$\pm 1$	$\mu A$
$\overline{FAULT}$ Output Logic Low Voltage	$V_{OL}$	$I_{SINK} = 1mA$ , $V_{IN} = 3V$			0.4	V
$\overline{FAULT}$ Output High Leakage Current		$V_{IN} = V_{\overline{FAULT}} = 5.5V$			1	$\mu A$
Fault-Blanking Timeout Period	$t_{FB}$	From overcurrent condition to $\overline{FAULT}$ assertion	6		14	ms
Switch Turn-On Time	$t_{ON}$	$I_{LOAD} = 400mA$			200	$\mu s$
Switch Turn-Off Time	$t_{OFF}$	$I_{LOAD} = 400mA$	1		20	$\mu s$

**Note 1:** MAX1693/(MAX1693H)'s current limit is tested by forcing  $V_{OUT}$  to 4.5V. The MAX1694's current limit is tested by increasing the output current until the switch is latched off.

**Note 2:** This specification applies to the MAX1693/(MAX1693H) only. The MAX1694 latches the switch off under a sustained (>10ms) short-circuit condition.

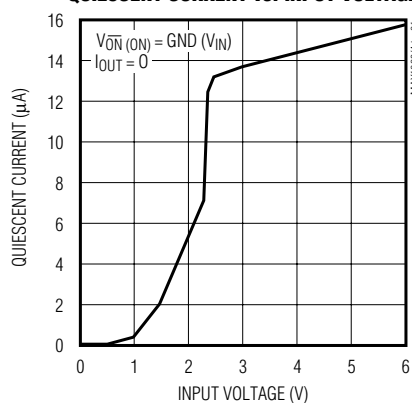
**Note 3:** Specifications to  $-40^{\circ}C$  are guaranteed by design, not production tested.

# USB Current-Limited Switches with Fault Blanking

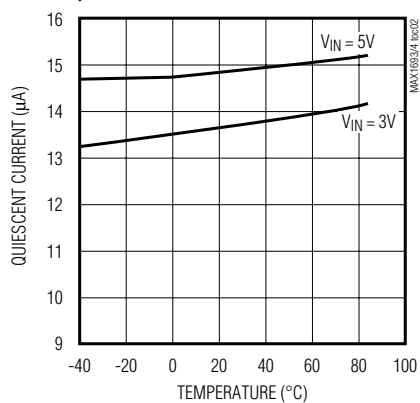
## Typical Operating Characteristics

( $V_{IN} = +5V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

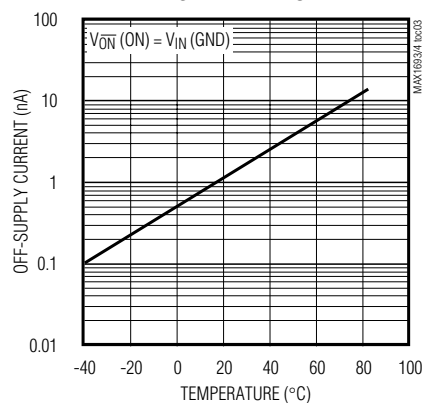
**QUIESCENT CURRENT vs. INPUT VOLTAGE**



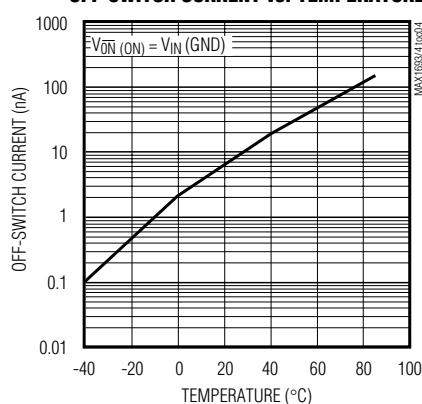
**QUIESCENT CURRENT vs. TEMPERATURE**



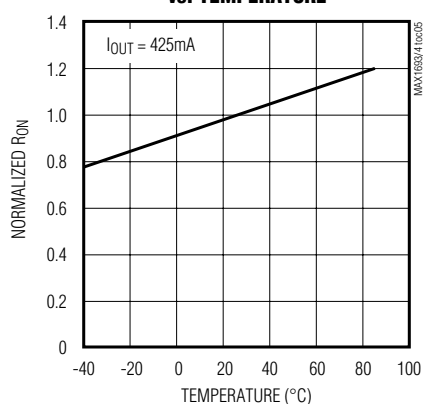
**OFF-SUPPLY CURRENT vs. TEMPERATURE**



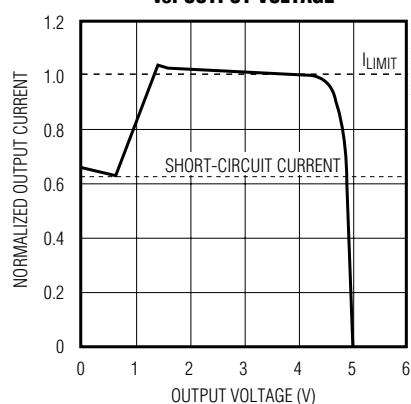
**OFF-SWITCH CURRENT vs. TEMPERATURE**



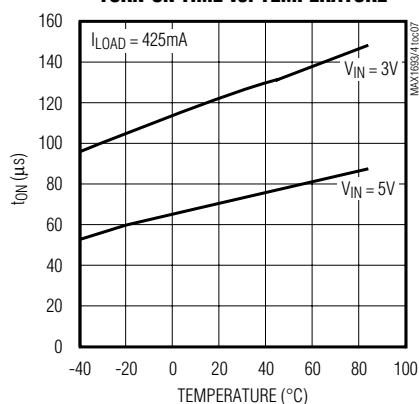
**NORMALIZED ON-RESISTANCE vs. TEMPERATURE**



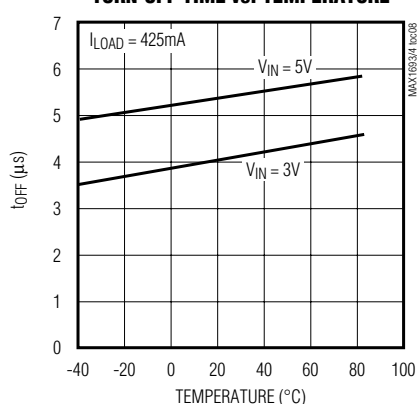
**NORMALIZED OUTPUT CURRENT vs. OUTPUT VOLTAGE**



**TURN-ON TIME vs. TEMPERATURE**



**TURN-OFF TIME vs. TEMPERATURE**

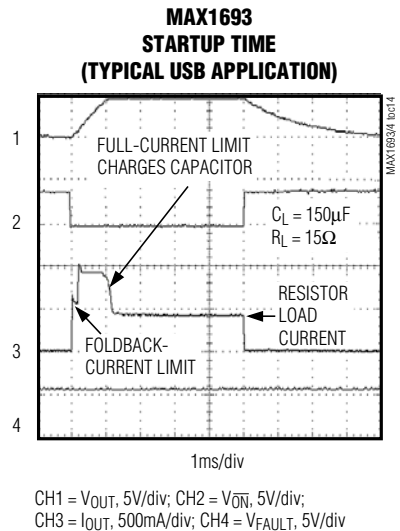
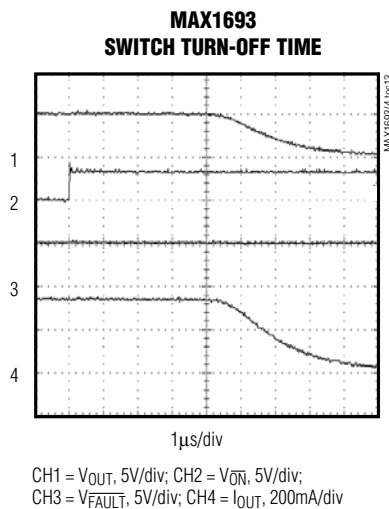
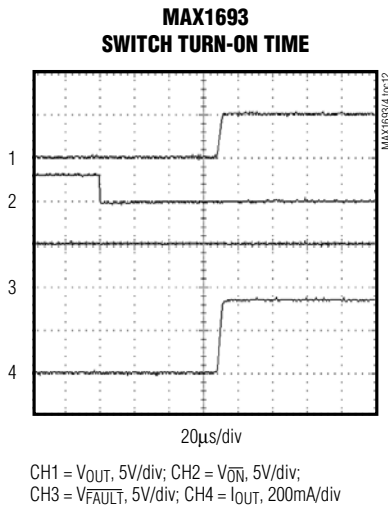
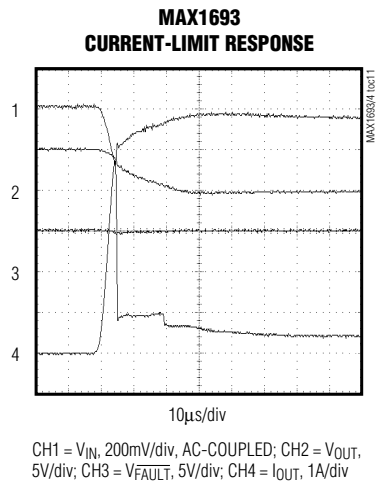
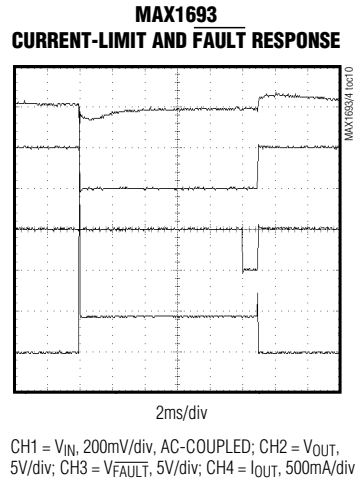
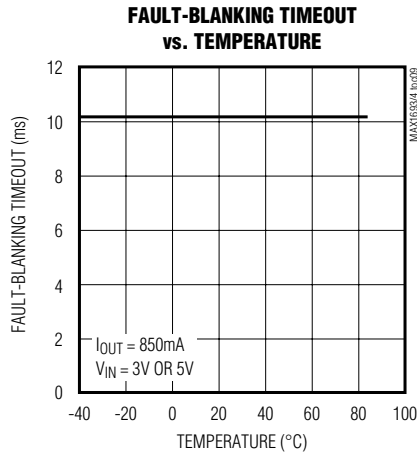


# USB Current-Limited Switches with Fault Blanking

## Typical Operating Characteristics (continued)

( $V_{IN} = +5V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

MAX1693/(MAX1693H)/MAX1694

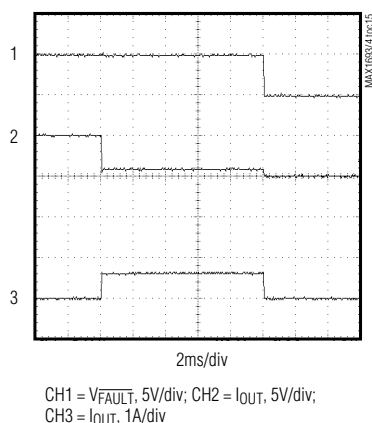


# USB Current-Limited Switches with Fault Blanking

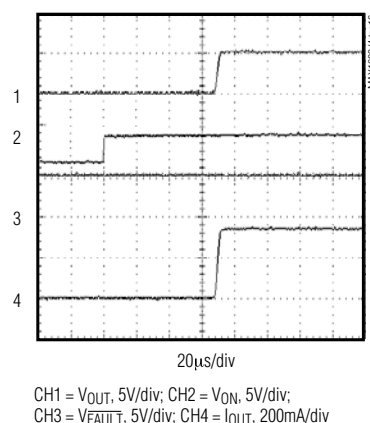
## Typical Operating Characteristics (continued)

( $V_{IN} = +5V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

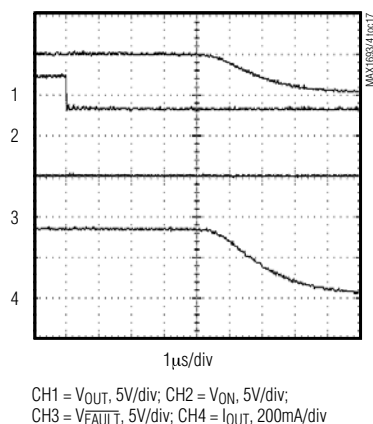
**MAX1694**  
**OVERCURRENT TO FAULT**  
**AND SWITCH LATCHED OFF**



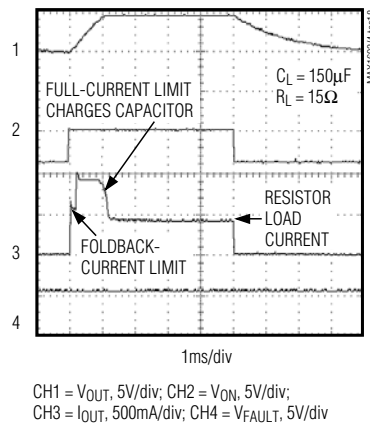
**MAX1693H**  
**SWITCH TURN-ON TIME**



**MAX1693H**  
**SWITCH TURN-OFF TIME**



**MAX1693H**  
**STARTUP TIME**  
**(TYPICAL USB APPLICATION)**



# USB Current-Limited Switches with Fault Blanking

## Pin Description

PIN	NAME	FUNCTION
1, 3, 9	IN	Input. P-channel MOSFET source. Connect all IN pins together and bypass with a 1 $\mu$ F ceramic capacitor to ground.
2, 4, 8, 10	OUT	Switch Output. P-channel MOSFET drain. Connect all OUT pins together and bypass with a 0.1 $\mu$ F capacitor to ground.
5	$\overline{\text{ON}}$ (ON)	Active-Low (High) Switch On Input. A logic low (high) turns the switch on.
6	GND	Ground
7	$\overline{\text{FAULT}}$	Fault-Indicator Output. This open-drain output goes low when the device is in thermal shut-down, undervoltage lockout, or on a sustained (>10ms) current-limit condition. For the MAX1694 only, this output latches low when asserted, and the power switch is turned off until the latch is reset.

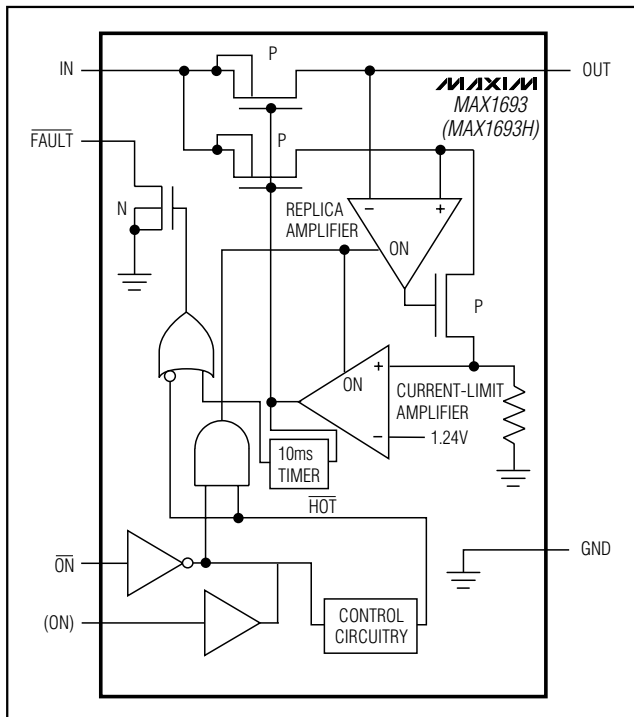


Figure 1. MAX1693 Functional Diagram

## Detailed Description

The MAX1693/(MAX1693H)/MAX1694 P-channel MOSFET power switches limit output current to 0.7A min to 1.0A max. When the output current is increased beyond the current limit ( $I_{LIMIT}$ ), the current also increases through the replica switch ( $I_{OUT/6500}$ ). The current-limit error amplifier compares the voltage to the internal 1.24V reference and regulates the current back to the  $I_{LIMIT}$ .

These switches are not bidirectional; therefore, the input voltage must be higher than the output voltage.

### Continuous Short-Circuit Protection

The MAX1693/(MAX1693H)/MAX1694 are foldback short circuit-protected switches. In the event of an output short-circuit or current-overload condition, the current through the switch is foldback-current limited to 500mA continuous for the MAX1693. For the MAX1694, if the short circuit lasts longer than 10ms, the switch is latched off.

### Thermal Shutdown

The MAX1693/(MAX1693H)/MAX1694 feature thermal shutdown. The switch turns off and the  $\overline{\text{FAULT}}$  output goes low immediately (no fault blanking) when the junction temperature exceeds +165°C. The MAX1694 remains latched with the switch off and the  $\overline{\text{FAULT}}$  output low. When the MAX1693/(MAX1693H) cools 20°C, the switch turns back on. If the fault short-circuit condition is not removed, the switch will cycle on and off, resulting in a pulsed output.

### $\overline{\text{FAULT}}$ Indicator

The MAX1693/(MAX1693H)/MAX1694 provide a fault output ( $\overline{\text{FAULT}}$ ). A 100k $\Omega$  pullup resistor from  $\overline{\text{FAULT}}$  to IN provides a logic control signal. This open-drain output goes low when any of the following conditions occur:

- The input voltage is below the undervoltage-lockout (UVLO) threshold.
- The die temperature exceeds the thermal shutdown temperature limit of +165°C.
- The device is in current limit and the 10ms fault-blanking period is exceeded.

# USB Current-Limited Switches with Fault Blanking

## Fault Blanking

The MAX1693/(MAX1693H)/MAX1694 feature 10ms fault blanking. Fault blanking allows current-limit faults, including momentary short-circuit faults that occur when hot-swapping a capacitive load, and also ensures that no fault is issued during power-up. When a load transient causes the device to enter current limit, an internal counter starts. If the load fault persists beyond the 10ms fault-blanking timeout, the  $\overline{\text{FAULT}}$  output asserts low. Ensure that the MAX1693/(MAX1693H)/MAX1694's input is adequately bypassed to prevent input glitches from triggering spurious  $\overline{\text{FAULT}}$  outputs. Input voltage glitches less than 150mV will not cause a spurious  $\overline{\text{FAULT}}$  output. Load-transient faults less than 10ms (typ) will not cause a  $\overline{\text{FAULT}}$  output assertion.

Only current-limit faults are blanked. Die overtemperature faults and input voltage droops below the UVLO threshold will cause an immediate fault output.

## Fault Latching (MAX1694 Only)

The MAX1694 features a latched  $\overline{\text{FAULT}}$  output. Whenever the  $\overline{\text{FAULT}}$  output is activated, it latches the  $\overline{\text{FAULT}}$  output low and also turns the switch off. To clear the latch, either cycle the  $\overline{\text{ON}}$  input or cycle the input voltage below UVLO.

## Applications Information

### Input Capacitor

To limit the input voltage drop during momentary output short-circuit conditions, connect a capacitor from IN to GND. A 1 $\mu$ F ceramic capacitor will be adequate for most applications; however, higher capacitor values will further reduce the voltage drop at the input (see Figure 2).

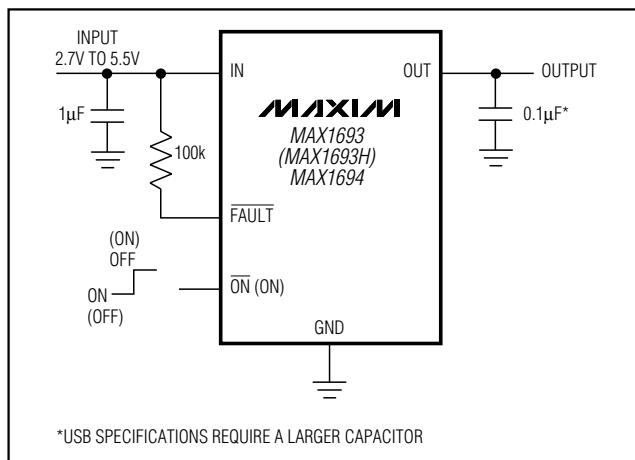


Figure 2. Typical Application Circuit

## Output Capacitor

Connect a 0.1 $\mu$ F capacitor from OUT to GND. This capacitor helps prevent inductive parasitics from pulling OUT negative during turn-off.

## Layout and Thermal Dissipation

To optimize the switch-response time to output short-circuit conditions, it is very important to keep all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close to the device as possible (no more than 5mm). All IN and all OUT pins must be connected with short traces to the power bus. Wide power bus planes will provide superior heat dissipation through the switch IN and OUT pins. Figure 3 shows suggested pin connections for a single-layer board.

Under normal operating conditions, the package can dissipate and channel heat away. Calculate the maximum power dissipation as follows:

$$P = (I_{\text{LIMIT}})^2 \times R_{\text{ON}}$$

where  $I_{\text{LIMIT}}$  is the preset current limit (1.0A max) and  $R_{\text{ON}}$  is the on-resistance of the switch (125m $\Omega$  max).

When the output is short-circuited, foldback-current limiting activates and the voltage drop across the switch equals the input supply. The power dissipated across the switch increases, as does the die temperature. If the fault condition is not removed, the thermal-overload-protection circuitry activates (see the *Thermal Shutdown* section). Wide power-bus planes connected to IN and OUT and a ground plane in contact with the device will help dissipate additional heat.

## Chip Information

TRANSISTOR COUNT: 715

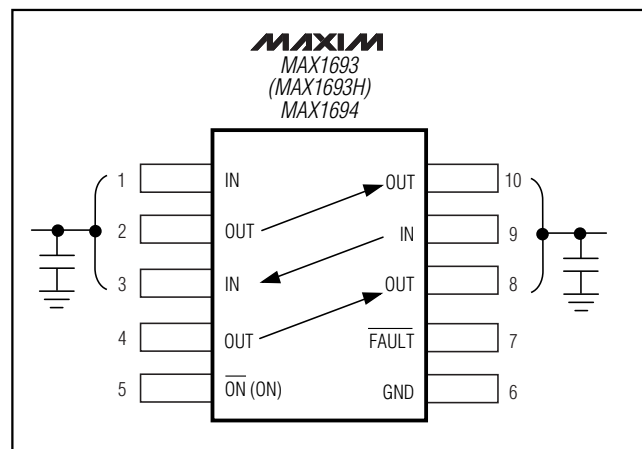


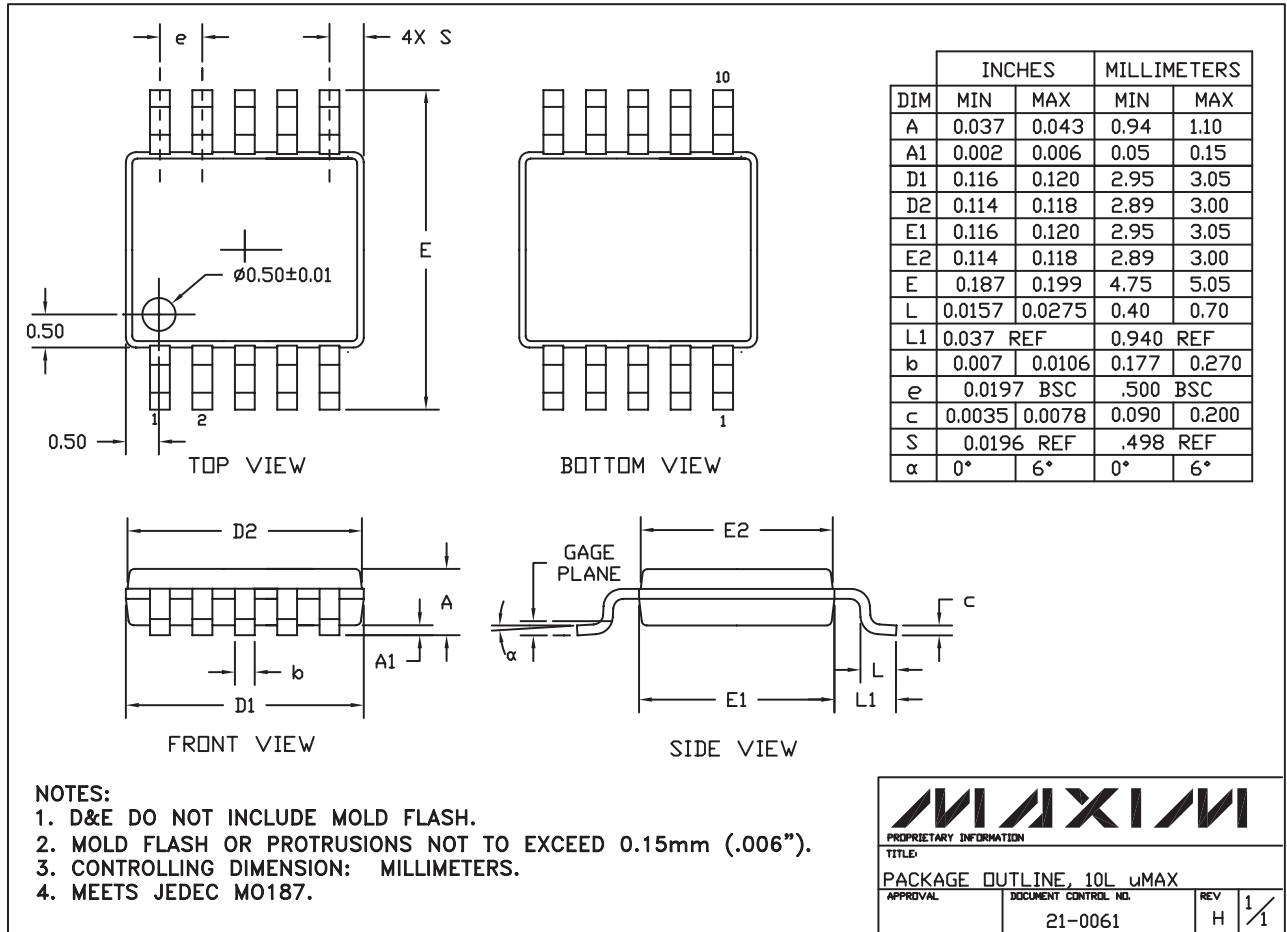
Figure 3. IN and OUT Cross Connections for a Single-Layer Board

# USB Current-Limited Switches with Fault Blanking

## Package Information

MAX1693/(MAX1693H)/MAX1694

10LUMAX.EPS



**Note:** Neither the MAX1693/(MAX1693H) nor MAX1694 has an exposed pad.

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